COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

<table>
<thead>
<tr>
<th>PCB VIEWED FROM TOP SIDE</th>
<th>BOARD #: 6590370</th>
<th>REV: A</th>
<th>SUN REV: Not In VersionControl</th>
</tr>
</thead>
<tbody>
<tr>
<td>TID #: TIDA-00725</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

PLOT NAME = Top Assembly Drawing
GENERATED: 11/19/2015 3:18:39 PM TEXAS INSTRUMENTS
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

<table>
<thead>
<tr>
<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: 6590370</th>
<th>REV: A</th>
<th>SUN REV: Not In VersionControl</th>
</tr>
</thead>
<tbody>
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<td>TID #: TIDA-00725</td>
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